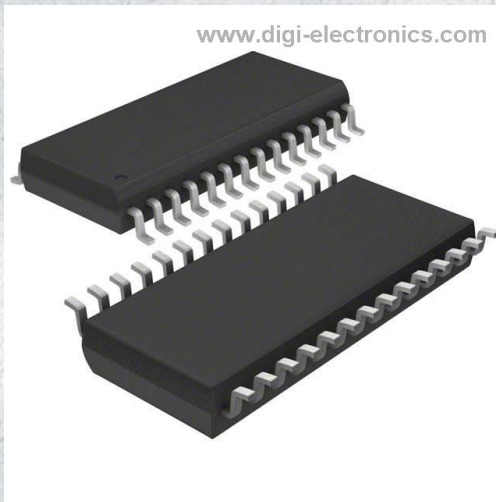


CY8C21534-12PVXET Datasheet



<https://www.DiGi-Electronics.com>

| | |
|------------------------------|---|
| DiGi Electronics Part Number | CY8C21534-12PVXET-DG |
| Manufacturer | Infineon Technologies |
| Manufacturer Product Number | CY8C21534-12PVXET |
| Description | IC MCU 8BIT 8KB FLASH 28SSOP |
| Detailed Description | M8C PSOC*1 CY8C21xxx Microcontroller IC 8-Bit 12M Hz 8KB (8K x 8) FLASH 28-SSOP |

This model CY8C21534-12PVXET is available at DiGi Electronics.

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Purchase and inquiry

Manufacturer Product Number:

CY8C21534-12PVXET

Series:

PSOC®1 CY8C21xxx

DiGi-Electronics Programmable:

Verified

Core Size:

8-Bit

Connectivity:

I2C, SPI, UART/USART

Number of I/O:

24

Program Memory Type:

FLASH

RAM Size:

512 x 8

Data Converters:

A/D 28x8b

Operating Temperature:

-40°C ~ 125°C (TA)

Supplier Device Package:

28-SSOP

Base Product Number:

CY8C21534

Manufacturer:

Infineon Technologies

Product Status:

Last Time Buy

Core Processor:

M8C

Speed:

12MHz

Peripherals:

POR, PWM, WDT

Program Memory Size:

8KB (8K x 8)

EEPROM Size:

-

Voltage - Supply (Vcc/Vdd):

2.4V ~ 5.25V

Oscillator Type:

Internal

Mounting Type:

Surface Mount

Package / Case:

28-SSOP (0.209", 5.30mm Width)

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.31.0001

Moisture Sensitivity Level (MSL):

3 (168 Hours)

ECCN:

EAR99



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CY8C21334/CY8C21534

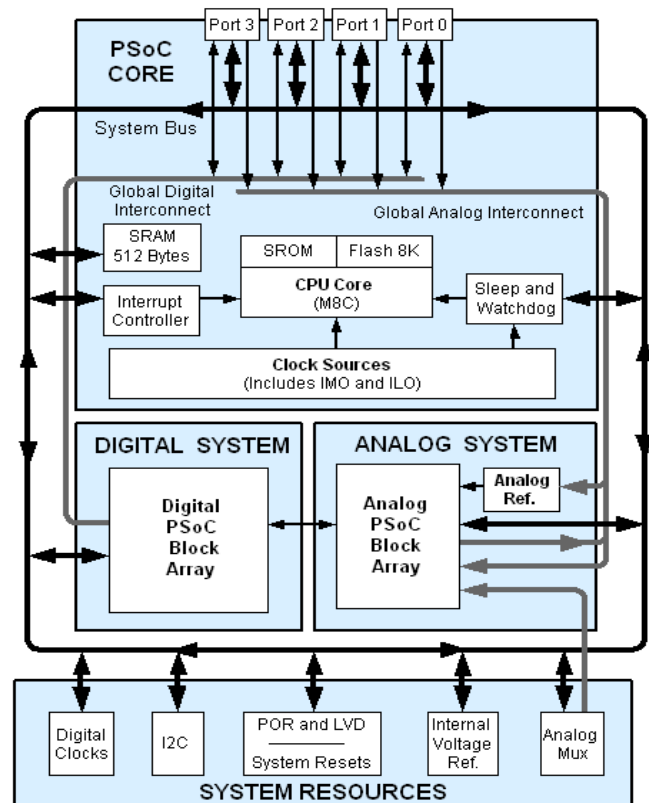
Automotive – Extended Temperature PSoC[®] Programmable System-on-Chip[™]

Features

- Automotive Electronics Council (AEC) Q100 qualified
- Powerful Harvard-architecture processor
 - M8C processor speeds up to 12 MHz
 - Low power at high speed
 - Operating voltage: 4.75 V to 5.25 V
 - Automotive temperature range: –40 °C to +125 °C
- Advanced peripherals (PSoC[®] blocks)
 - Four analog Type E PSoC blocks provide:
 - Two comparators with digital-to-analog converter (DAC) references
 - Up to 10-bit single or dual, 24 channel analog-to-digital converters (ADC)
 - Four digital PSoC blocks provide:
 - 8- to 32-bit timers, counters, and pulse width modulators (PWMs)
 - Cyclical redundancy check (CRC) and pseudo-random sequence (PRS) modules
 - Full- or half-duplex UART
 - SPI master or slave
 - Connectable to all general purpose I/O (GPIO) pins
 - Complex peripherals by combining blocks
 - Capacitive sensing application capability
- Flexible on-chip memory
 - 8 KB flash program storage
 - 512 bytes SRAM data storage
 - In-system serial programming (ISSP)
 - Partial flash updates
 - Flexible protection modes
 - EEPROM emulation in flash
- Complete development tools
 - Free development software (PSoC Designer[™])
 - Full-featured in-circuit emulator (ICE) and programmer
 - Full-speed emulation
 - Complex breakpoint structure
 - 128 KB trace memory
- Precision, programmable clocking
 - Internal 24 MHz oscillator
 - Internal low-speed, low-power oscillator for Watchdog and Sleep functionality
 - Optional external oscillator, up to 24 MHz
- Programmable pin configurations
 - 25 mA sink, 10 mA drive on all GPIOs

- Pull-up, pull-down, high Z, strong, or open drain drive modes on all GPIOs
- Analog input on all GPIOs
- Configurable interrupt on all GPIOs
- Versatile analog mux
 - Common internal analog bus
 - Simultaneous connection of I/O combinations
- Additional system resources
 - Inter-Integrated Circuit (I²C[™]) master, slave, or multi-master operation up to 400 kHz
 - Watchdog and sleep timers
 - User-configurable low-voltage detection (LVD)
 - Integrated supervisory circuit
 - On-chip precision voltage reference

Logic Block Diagram





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PSoC Functional Overview

The PSoC family consists of many devices with on-chip controllers. These devices are designed to replace multiple traditional microcontroller unit (MCU)-based system components with one, low-cost single-chip programmable component. A PSoC device includes configurable blocks of analog and digital logic, and programmable interconnect. This architecture makes it possible for you to create customized peripheral configurations, to match the requirements of each individual application. Additionally, a fast central processing unit (CPU), flash program memory, SRAM data memory, and configurable I/O are included in a range of convenient pinouts.

The PSoC architecture, as illustrated in the [Logic Block Diagram on page 1](#), comprises of four main areas: the core, the system resources, the digital system, and the analog system. Configurable global bus resources allow all the device resources to be combined into a complete custom system. Each CY8C21x34 PSoC device includes four digital blocks and four analog blocks. Depending on the PSoC package, up to 24 GPIOs are also included. The GPIOs provide access to the global digital and analog interconnects.

The PSoC Core

The PSoC core is a powerful engine that supports a rich instruction set. It encompasses SRAM for data storage, an interrupt controller, sleep, and watchdog timers, and an internal main oscillator (IMO) and internal low-speed oscillator (ILO). The CPU core, called the M8C, is a powerful processor with speeds up to 12 MHz. The M8C is a two-million instructions per second (MIPS) 8-bit Harvard-architecture microprocessor.

System resources provide additional capability, such as digital clocks for increased flexibility, I²C functionality for implementing an I²C master, slave, or multi-master, an internal voltage reference that provides an absolute value of 1.3 V to a number of PSoC subsystems, and various system resets supported by the M8C.

The digital system is composed of an array of digital PSoC blocks, which can be configured into any number of digital peripherals. The digital blocks can be connected to the GPIO through a series of global buses that can route any signal to any pin. This frees designs from the constraints of a fixed peripheral controller.

The analog system is composed of four analog PSoC blocks, supporting comparators and analog-to-digital conversion with up to 10 bits of precision.

The Digital System

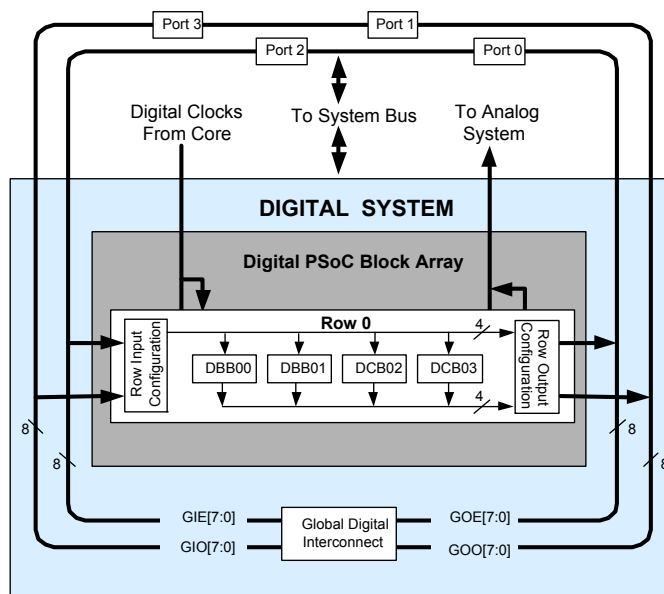
The digital system is composed of four digital PSoC blocks. Each block is an 8-bit resource that can be used alone or combined with other blocks to form 8-, 16-, 24-, and 32-bit peripherals,

which are called user modules. Digital peripheral configurations include those listed.

- PWMs (8- to 32-bit)
- PWMs with dead band (8- to 24-bit)
- Counters (8- to 32-bit)
- Timers (8- to 32-bit)
- Full or half-duplex 8-bit UART with selectable parity
- SPI master and slave
- I²C master, slave, or multi-master (implemented in a dedicated I²C block)
- Cyclical redundancy checker/generator (16-bit)
- Infrared Data Association (IrDA)
- PRS generators (8- to 32-bit)

The digital blocks can be connected to any GPIO through a series of global buses that can route any signal to any pin. The buses also allow for signal multiplexing and for performing logic operations. This configurability frees your designs from the constraints of a fixed peripheral controller.

Figure 1. Digital System Block Diagram



Digital blocks are provided in rows of four, where the number of blocks varies by PSoC device family. This allows you the optimum choice of system resources for your application. Family resources are shown in [Table 1 on page 5](#).

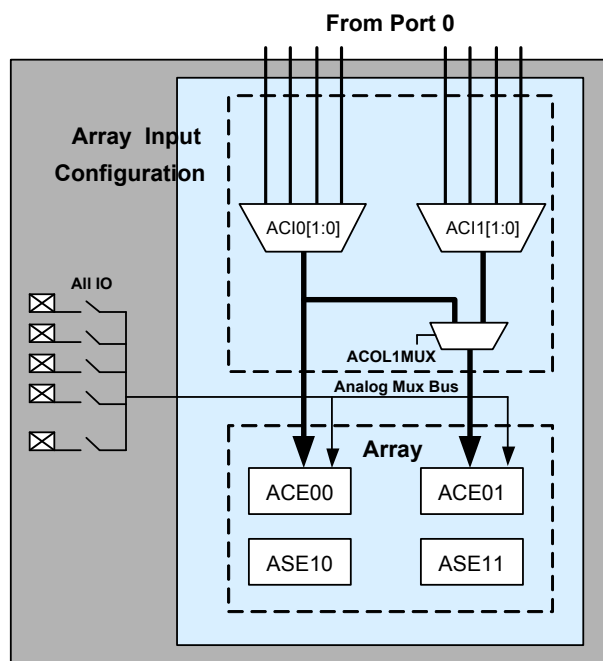
The Analog System

The analog system is composed of four configurable blocks, allowing the creation of complex analog signal flows. Analog peripherals are very flexible and can be customized to support specific application requirements. Some of the common PSoC analog functions for this device (most available as user modules) are listed.

- ADCs (single or dual, with up to 10-bit resolution)
- Pin-to-pin comparator
- Single-ended comparators (up to two) with absolute (1.3 V) reference or 8-bit DAC reference
- 1.3 V reference (as a system resource)

In most PSoC devices, analog blocks are provided in columns of three, which includes one continuous time (CT) and two switched capacitor (SC) blocks. The CY8C21x34 devices provide limited functionality type 'E' analog blocks. Each column contains one CT type 'E' block and one SC type 'E' block. Refer to the [PSoC Programmable System-on-Chip Technical Reference Manual](#) for detailed information on the CY8C21x34's type 'E' analog blocks.

Figure 2. Analog System Block Diagram



The Analog Multiplexer System

The analog mux bus can connect to every GPIO pin. Pins can be connected to the bus individually or in any combination. The bus also connects to the analog system for analysis with comparators and ADCs. An additional 8:1 analog input multiplexer provides a second path to bring Port 0 pins to the analog array.

Switch-control logic enables selected pins to precharge continuously under hardware control. This enables capacitive measurement for applications such as touch sensing. Other multiplexer applications include:

- Track pad, finger sensing.
- Chip-wide mux that allows analog input from any I/O pin.
- Crosspoint connection between any I/O pin combination.

Additional System Resources

System resources, some of which have been previously listed, provide additional capability useful for complete systems. Brief statements describing the merits of each system resource are presented.

- Digital clock dividers provide three customizable clock frequencies for use in applications. The clocks can be routed to both the digital and analog systems. Additional clocks can be generated using digital PSoC blocks as clock dividers.
- The I²C module provides communication up to 400 kHz over two wires. Slave, master, and multi-master modes are all supported.
- LVD interrupts can signal the application of falling voltage levels, while the advanced power-on reset (POR) circuit eliminates the need for a system supervisor.
- An internal 1.3-V voltage reference provides an absolute reference for the analog system, including ADCs and DACs.
- Versatile analog multiplexer system



PSoC Device Characteristics

Depending on your PSoC device characteristics, the digital and analog systems can have a varying number of digital and analog blocks. The following table lists the resources available for specific PSoC device groups. The PSoC device covered by this data sheet is highlighted in [Table 1](#).

Table 1. PSoC Device Characteristics

| PSoC Part Number | Digital I/O | Digital Rows | Digital Blocks | Analog Inputs | Analog Outputs | Analog Columns | Analog Blocks | SRAM Size | Flash Size |
|---------------------------|-------------|--------------|----------------|---------------|----------------|----------------|-----------------------------|-----------|------------|
| CY8C29x66 ^[1] | up to 64 | 4 | 16 | up to 12 | 4 | 4 | 12 | 2 K | 32 K |
| CY8C28xxx | up to 44 | up to 3 | up to 12 | up to 44 | up to 4 | up to 6 | up to 12 + 4 ^[2] | 1 K | 16 K |
| CY8C27x43 | up to 44 | 2 | 8 | up to 12 | 4 | 4 | 12 | 256 | 16 K |
| CY8C24x94 ^[1] | up to 56 | 1 | 4 | up to 48 | 2 | 2 | 6 | 1 K | 16 K |
| CY8C24x23A ^[1] | up to 24 | 1 | 4 | up to 12 | 2 | 2 | 6 | 256 | 4 K |
| CY8C23x33 | up to 26 | 1 | 4 | up to 12 | 2 | 2 | 4 | 256 | 8 K |
| CY8C22x45 ^[1] | up to 38 | 2 | 8 | up to 38 | 0 | 4 | 6 ^[2] | 1 K | 16 K |
| CY8C21x45 ^[1] | up to 24 | 1 | 4 | up to 24 | 0 | 4 | 6 ^[2] | 512 | 8 K |
| CY8C21x34 ^[1] | up to 28 | 1 | 4 | up to 28 | 0 | 2 | 4 ^[2] | 512 | 8 K |
| CY8C21x23 | up to 16 | 1 | 4 | up to 8 | 0 | 2 | 4 ^[2] | 256 | 4 K |
| CY8C20x34 ^[1] | up to 28 | 0 | 0 | up to 28 | 0 | 0 | 3 ^[2,3] | 512 | 8 K |
| CY8C20xx6 | up to 36 | 0 | 0 | up to 36 | 0 | 0 | 3 ^[2,3] | up to 2 K | up to 32 K |

Getting Started

For in-depth information, along with detailed programming details, see the *PSoC[®] Technical Reference Manual*.

For up-to-date ordering, packaging, and electrical specification information, see the latest [PSoC device datasheets](#) on the web.

Application Notes

[Cypress application notes](#) are an excellent introduction to the wide variety of possible PSoC designs.

Development Kits

[PSoC Development Kits](#) are available online from and through a growing number of regional and global distributors, which include Arrow, Avnet, Digi-Key, Farnell, Future Electronics, and Newark.

Training

[Free PSoC technical training](#) (on demand, webinars, and workshops), which is available online via www.cypress.com, covers a wide variety of topics and skill levels to assist you in your designs.

CYPros Consultants

Certified PSoC consultants offer everything from technical assistance to completed PSoC designs. To contact or become a PSoC consultant go to the [CYPros Consultants](#) web site.

Solutions Library

Visit our growing [library of solution focused designs](#). Here you can find various application designs that include firmware and hardware design files that enable you to complete your designs quickly.

Technical Support

[Technical support](#) – including a searchable Knowledge Base articles and technical forums – is also available online. If you cannot find an answer to your question, call our Technical Support hotline at 1-800-541-4736.

Notes

1. Automotive qualified devices available in this group.
2. Limited analog functionality.
3. Two analog blocks and one CapSense[®] block.



Development Tools

PSoC Designer™ is the revolutionary integrated design environment (IDE) that you can use to customize PSoC to meet your specific application requirements. PSoC Designer software accelerates system design and time to market. Develop your applications using a library of precharacterized analog and digital peripherals (called user modules) in a drag-and-drop design environment. Then, customize your design by leveraging the dynamically generated application programming interface (API) libraries of code. Finally, debug and test your designs with the integrated debug environment, including in-circuit emulation and standard software debug features. PSoC Designer includes:

- Application editor graphical user interface (GUI) for device and user module configuration and dynamic reconfiguration
- Extensive user module catalog
- Integrated source-code editor (C and assembly)
- Free C compiler with no size restrictions or time limits
- Built-in debugger
- In-circuit emulation
- Built-in support for communication interfaces:
 - Hardware and software I²C slaves and masters
 - Full-speed USB 2.0
 - Up to four full-duplex universal asynchronous receiver/transmitters (UARTs), SPI master and slave, and wireless

PSoC Designer supports the entire library of PSoC 1 devices and runs on Windows XP, Windows Vista, and Windows 7.

PSoC Designer Software Subsystems

Design Entry

In the chip-level view, choose a base device to work with. Then select different onboard analog and digital components that use the PSoC blocks, which are called user modules. Examples of user modules are ADCs, DACs, amplifiers, and filters. Configure the user modules for your chosen application and connect them to each other and to the proper pins. Then generate your project. This prepopulates your project with APIs and libraries that you can use to program your application.

The tool also supports easy development of multiple configurations and dynamic reconfiguration. Dynamic reconfiguration makes it possible to change configurations at run time. In essence, this allows you to use more than 100 percent of PSoC's resources for an application.

Code Generation Tools

The code generation tools work seamlessly within the PSoC Designer interface and have been tested with a full range of debugging tools. You can develop your design in C, assembly, or a combination of the two.

Assemblers. The assemblers allow you to merge assembly code seamlessly with C code. Link libraries automatically use absolute addressing or are compiled in relative mode, and are linked with other software modules to get absolute addressing.

C Language Compilers. C language compilers are available that support the PSoC family of devices. The products allow you to create complete C programs for the PSoC family devices. The optimizing C compilers provide all of the features of C, tailored to the PSoC architecture. They come complete with embedded libraries providing port and bus operations, standard keypad and display support, and extended math functionality.

Debugger

PSoC Designer has a debug environment that provides hardware in-circuit emulation, allowing you to test the program in a physical system while providing an internal view of the PSoC device. Debugger commands allow you to read and program and read and write data memory, and read and write I/O registers. You can read and write CPU registers, set and clear breakpoints, and provide program run, halt, and step control. The debugger also allows you to create a trace buffer of registers and memory locations of interest.

Online Help System

The online help system displays online, context-sensitive help. Designed for procedural and quick reference, each functional subsystem has its own context-sensitive help. This system also provides tutorials and links to FAQs and an online support Forum to aid the designer.

In-Circuit Emulator

A low-cost, high-functionality in-circuit emulator (ICE) is available for development support. This hardware can program single devices.

The emulator consists of a base unit that connects to the PC using a USB port. The base unit is universal and operates with all PSoC devices. Emulation pods for each device family are available separately. The emulation pod takes the place of the PSoC device in the target board and performs full-speed (24 MHz) operation.



Designing with PSoC Designer

The development process for the PSoC device differs from that of a traditional fixed function microprocessor. The configurable analog and digital hardware blocks give the PSoC architecture a unique flexibility that pays dividends in managing specification change during development and by lowering inventory costs. These configurable resources, called PSoC Blocks, have the ability to implement a wide variety of user-selectable functions.

The PSoC development process can be summarized in the following four steps:

1. Select [User Modules](#)
2. Configure User Modules
3. Organize and Connect
4. Generate, Verify, and Debug

Select Components

PSoC Designer provides a library of pre-built, pre-tested hardware peripheral components called “user modules.” User modules make selecting and implementing peripheral devices, both analog and digital, simple.

Configure Components

Each of the User Modules you select establishes the basic register settings that implement the selected function. They also provide parameters and properties that allow you to tailor their precise configuration to your particular application. For example, a PWM User Module configures one or more

digital PSoC blocks, one for each 8 bits of resolution. The user module parameters permit you to establish the pulse width and duty cycle. Configure the parameters and properties to correspond to your chosen application. Enter values directly or by selecting values from drop-down menus. All the user modules are documented in datasheets that may be viewed directly in PSoC Designer or on the Cypress website. These [user module datasheets](#) explain the internal operation of the User Module and

provide performance specifications. Each datasheet describes the use of each user module parameter, and other information you may need to successfully implement your design.

Organize and Connect

You build signal chains at the chip level by interconnecting user modules to each other and the I/O pins. You perform the selection, configuration, and routing so that you have complete control over all on-chip resources.

Generate, Verify, and Debug

When you are ready to test the hardware configuration or move on to developing code for the project, you perform the “Generate Configuration Files” step. This causes PSoC Designer to generate source code that automatically configures the device to your specification and provides the software for the system. The generated code provides application programming interfaces (APIs) with high-level functions to control and respond to hardware events at run time and interrupt service routines that you can adapt as needed.

A complete code development environment allows you to develop and customize your applications in C, assembly language, or both.

The last step in the development process takes place inside PSoC Designer's Debugger (access by clicking the Connect icon). PSoC Designer downloads the HEX image to the ICE where it runs at full speed. PSoC Designer debugging capabilities rival those of systems costing many times more. In addition to traditional single-step, run-to-breakpoint and watch-variable features, the debug interface provides a large trace buffer and allows you to define complex breakpoint events that include monitoring address and data bus values, memory locations and external signals.

Pinouts

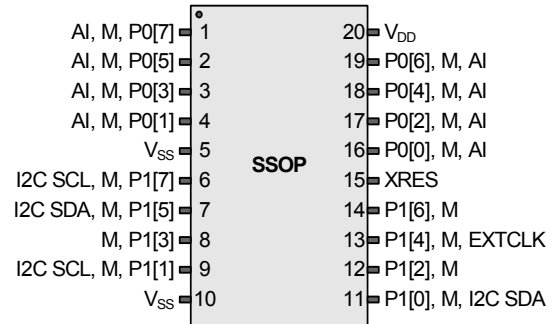
The automotive CY8C21x34 PSoC device is available in a variety of packages which are listed and illustrated in the following tables. Every port pin (labeled with a "P") is capable of digital I/O and connection to the common analog bus. However, V_{SS} , V_{DD} , and XRES are not capable of digital I/O.

20-pin Part Pinout

Table 2. 20-pin Part Pinout (SSOP)

| Pin No. | Type | | Name | Description |
|---------|---------|--------|----------|---|
| | Digital | Analog | | |
| 1 | I/O | I, M | P0[7] | Analog column mux input |
| 2 | I/O | I, M | P0[5] | Analog column mux input |
| 3 | I/O | I, M | P0[3] | Analog column mux input, C_{MOD} capacitor pin |
| 4 | I/O | I, M | P0[1] | Analog column mux input, C_{MOD} capacitor pin |
| 5 | Power | | V_{SS} | Ground connection |
| 6 | I/O | M | P1[7] | I ² C serial clock (SCL) |
| 7 | I/O | M | P1[5] | I ² C serial data (SDA) |
| 8 | I/O | M | P1[3] | |
| 9 | I/O | M | P1[1] | I ² C serial clock (SCL), ISSP-SCLK ^[4] |
| 10 | Power | | V_{SS} | Ground connection |
| 11 | I/O | M | P1[0] | I ² C serial data (SDA), ISSP-SDATA ^[4] |
| 12 | I/O | M | P1[2] | |
| 13 | I/O | M | P1[4] | Optional external clock (EXTCLK) input |
| 14 | I/O | M | P1[6] | |
| 15 | Input | | XRES | Active high external reset with internal pull-down |
| 16 | I/O | I, M | P0[0] | Analog column mux input |
| 17 | I/O | I, M | P0[2] | Analog column mux input |
| 18 | I/O | I, M | P0[4] | Analog column mux input |
| 19 | I/O | I, M | P0[6] | Analog column mux input |
| 20 | Power | | V_{DD} | Supply voltage |

Figure 3. CY8C21334 20-Pin PSoC Device



LEGEND A = Analog, I = Input, O = Output, and M = Analog Mux Input.

Note

4. These are the ISSP pins, which are not high Z when coming out of POR. See the [PSoC Technical Reference Manual](#) for details.

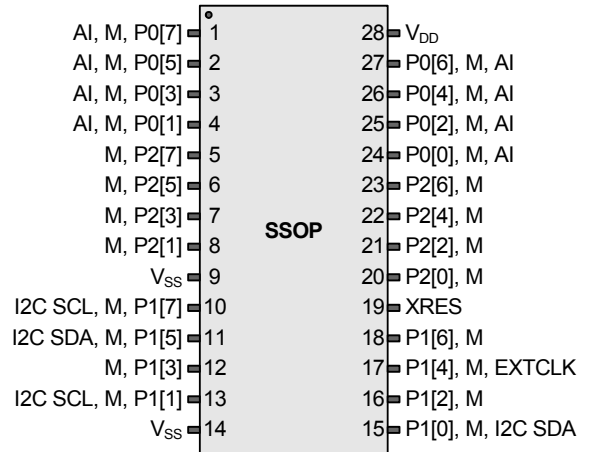
28-pin Part Pinout

Table 3. 28-pin Part Pinout (SSOP)

| Pin No. | Type | | Name | Description |
|---------|---------|--------|-----------------|---|
| | Digital | Analog | | |
| 1 | I/O | I, M | P0[7] | Analog column mux input |
| 2 | I/O | I, M | P0[5] | Analog column mux input |
| 3 | I/O | I, M | P0[3] | Analog column mux input, C _{MOD} capacitor pin |
| 4 | I/O | I, M | P0[1] | Analog column mux input, C _{MOD} capacitor pin |
| 5 | I/O | M | P2[7] | |
| 6 | I/O | M | P2[5] | |
| 7 | I/O | M | P2[3] | |
| 8 | I/O | M | P2[1] | |
| 9 | Power | | V _{SS} | Ground connection |
| 10 | I/O | M | P1[7] | I ² C serial clock (SCL) |
| 11 | I/O | M | P1[5] | I ² C serial data (SDA) |
| 12 | I/O | M | P1[3] | |
| 13 | I/O | M | P1[1] | I ² C serial clock (SCL), ISSP-SCLK ^[5] |
| 14 | Power | | V _{SS} | Ground connection |
| 15 | I/O | M | P1[0] | I ² C serial data (SDA), ISSP-SDATA ^[5] |
| 16 | I/O | M | P1[2] | |
| 17 | I/O | M | P1[4] | Optional external clock (EXTCLK) input |
| 18 | I/O | M | P1[6] | |
| 19 | Input | | XRES | Active high external reset with internal pull-down |
| 20 | I/O | M | P2[0] | |
| 21 | I/O | M | P2[2] | |
| 22 | I/O | M | P2[4] | |
| 23 | I/O | M | P2[6] | |
| 24 | I/O | I, M | P0[0] | Analog column mux input |
| 25 | I/O | I, M | P0[2] | Analog column mux input |
| 26 | I/O | I, M | P0[4] | Analog column mux input |
| 27 | I/O | I, M | P0[6] | Analog column mux input |
| 28 | Power | | V _{DD} | Supply voltage |

LEGEND A = Analog, I = Input, O = Output, and M = Analog Mux Input.

Figure 4. CY8C21534 28-pin PSoC Device

**Note**

5. These are the ISSP pins, which are not high Z when coming out of POR. See the *PSoC Technical Reference Manual* for details.



Registers

Register Conventions

This section lists the registers of the automotive CY8C21x34 PSoC device. For detailed register information, reference the [PSoC Technical Reference Manual](#).

The register conventions specific to this section are listed in [Table 4](#).

Table 4. Register Conventions

| Convention | Description |
|------------|------------------------------|
| R | Read register or bit(s) |
| W | Write register or bit(s) |
| L | Logical register or bit(s) |
| C | Clearable register or bit(s) |
| # | Access is bit specific |

Register Mapping Tables

The PSoC device has a total register address space of 512 bytes. The register space is referred to as I/O space and is divided into two banks. The XIO bit in the Flag register (CPU_F) determines which bank the user is currently in. When the XIO bit is set the user is in Bank 1.

Note In the following register mapping tables, blank fields are Reserved and must not be accessed.



Table 5. Register Map 0 Table: User Space

| Name | Addr (0,Hex) | Access | Name | Addr (0,Hex) | Access | Name | Addr (0,Hex) | Access | Name | Addr (0,Hex) | Access |
|----------|--------------|--------|----------|--------------|--------|----------|--------------|--------|----------|--------------|--------|
| PRT0DR | 00 | RW | | 40 | | ASE10CR0 | 80 | RW | | C0 | |
| PRT0IE | 01 | RW | | 41 | | | 81 | | | C1 | |
| PRT0GS | 02 | RW | | 42 | | | 82 | | | C2 | |
| PRT0DM2 | 03 | RW | | 43 | | | 83 | | | C3 | |
| PRT1DR | 04 | RW | | 44 | | ASE11CR0 | 84 | RW | | C4 | |
| PRT1IE | 05 | RW | | 45 | | | 85 | | | C5 | |
| PRT1GS | 06 | RW | | 46 | | | 86 | | | C6 | |
| PRT1DM2 | 07 | RW | | 47 | | | 87 | | | C7 | |
| PRT2DR | 08 | RW | | 48 | | | 88 | | | C8 | |
| PRT2IE | 09 | RW | | 49 | | | 89 | | | C9 | |
| PRT2GS | 0A | RW | | 4A | | | 8A | | | CA | |
| PRT2DM2 | 0B | RW | | 4B | | | 8B | | | CB | |
| | 0C | | | 4C | | | 8C | | | CC | |
| | 0D | | | 4D | | | 8D | | | CD | |
| | 0E | | | 4E | | | 8E | | | CE | |
| | 0F | | | 4F | | | 8F | | | CF | |
| | 10 | | | 50 | | | 90 | | CUR_PP | D0 | RW |
| | 11 | | | 51 | | | 91 | | STK_PP | D1 | RW |
| | 12 | | | 52 | | | 92 | | | D2 | |
| | 13 | | | 53 | | | 93 | | IDX_PP | D3 | RW |
| | 14 | | | 54 | | | 94 | | MVR_PP | D4 | RW |
| | 15 | | | 55 | | | 95 | | MVW_PP | D5 | RW |
| | 16 | | | 56 | | | 96 | | I2C_CFG | D6 | RW |
| | 17 | | | 57 | | | 97 | | I2C_SCR | D7 | # |
| | 18 | | | 58 | | | 98 | | I2C_DR | D8 | RW |
| | 19 | | | 59 | | | 99 | | I2C_MSCR | D9 | # |
| | 1A | | | 5A | | | 9A | | INT_CLR0 | DA | RW |
| | 1B | | | 5B | | | 9B | | INT_CLR1 | DB | RW |
| | 1C | | | 5C | | | 9C | | | DC | |
| | 1D | | | 5D | | | 9D | | INT_CLR3 | DD | RW |
| | 1E | | | 5E | | | 9E | | INT_MSK3 | DE | RW |
| | 1F | | | 5F | | | 9F | | | DF | |
| DBB00DR0 | 20 | # | AMX_IN | 60 | RW | | A0 | | INT_MSK0 | E0 | RW |
| DBB00DR1 | 21 | W | AMUX_CFG | 61 | RW | | A1 | | INT_MSK1 | E1 | RW |
| DBB00DR2 | 22 | RW | PWM_CR | 62 | RW | | A2 | | INT_VC | E2 | RC |
| DBB00CR0 | 23 | # | | 63 | | | A3 | | RES_WDT | E3 | W |
| DBB01DR0 | 24 | # | CMP_CR0 | 64 | # | | A4 | | | E4 | |
| DBB01DR1 | 25 | W | | 65 | | | A5 | | | E5 | |
| DBB01DR2 | 26 | RW | CMP_CR1 | 66 | RW | | A6 | | DEC_CR0 | E6 | RW |
| DBB01CR0 | 27 | # | | 67 | | | A7 | | DEC_CR1 | E7 | RW |
| DCB02DR0 | 28 | # | ADC0_CR | 68 | # | | A8 | | | E8 | |
| DCB02DR1 | 29 | W | ADC1_CR | 69 | # | | A9 | | | E9 | |
| DCB02DR2 | 2A | RW | | 6A | | | AA | | | EA | |
| DCB02CR0 | 2B | # | | 6B | | | AB | | | EB | |
| DCB03DR0 | 2C | # | TMP_DR0 | 6C | RW | | AC | | | EC | |
| DCB03DR1 | 2D | W | TMP_DR1 | 6D | RW | | AD | | | ED | |
| DCB03DR2 | 2E | RW | TMP_DR2 | 6E | RW | | AE | | | EE | |
| DCB03CR0 | 2F | # | TMP_DR3 | 6F | RW | | AF | | | EF | |
| | 30 | | | 70 | | RDI0RI | B0 | RW | | F0 | |
| | 31 | | | 71 | | RDI0SYN | B1 | RW | | F1 | |
| | 32 | | ACE00CR1 | 72 | RW | RDI0IS | B2 | RW | | F2 | |
| | 33 | | ACE00CR2 | 73 | RW | RDI0LT0 | B3 | RW | | F3 | |
| | 34 | | | 74 | | RDI0LT1 | B4 | RW | | F4 | |
| | 35 | | | 75 | | RDI0RO0 | B5 | RW | | F5 | |
| | 36 | | ACE01CR1 | 76 | RW | RDI0RO1 | B6 | RW | | F6 | |
| | 37 | | ACE01CR2 | 77 | RW | | B7 | | CPU_F | F7 | RL |
| | 38 | | | 78 | | | B8 | | | F8 | |
| | 39 | | | 79 | | | B9 | | | F9 | |
| | 3A | | | 7A | | | BA | | | FA | |
| | 3B | | | 7B | | | BB | | | FB | |
| | 3C | | | 7C | | | BC | | | FC | |
| | 3D | | | 7D | | | BD | | DAC_D | FD | RW |
| | 3E | | | 7E | | | BE | | CPU_SCR1 | FE | # |
| | 3F | | | 7F | | | BF | | CPU_SCR0 | FF | # |

Blank fields are Reserved and must not be accessed.

Access is bit specific.



Table 6. Register Map 1 Table: Configuration Space

| Name | Addr (1,Hex) | Access | Name | Addr (1,Hex) | Access | Name | Addr (1,Hex) | Access | Name | Addr (1,Hex) | Access |
|---------|--------------|--------|-----------|--------------|--------|----------|--------------|--------|-----------|--------------|--------|
| PRT0DM0 | 00 | RW | | 40 | | ASE10CR0 | 80 | RW | | C0 | |
| PRT0DM1 | 01 | RW | | 41 | | | 81 | | | C1 | |
| PRT0IC0 | 02 | RW | | 42 | | | 82 | | | C2 | |
| PRT0IC1 | 03 | RW | | 43 | | | 83 | | | C3 | |
| PRT1DM0 | 04 | RW | | 44 | | ASE11CR0 | 84 | RW | | C4 | |
| PRT1DM1 | 05 | RW | | 45 | | | 85 | | | C5 | |
| PRT1IC0 | 06 | RW | | 46 | | | 86 | | | C6 | |
| PRT1IC1 | 07 | RW | | 47 | | | 87 | | | C7 | |
| PRT2DM0 | 08 | RW | | 48 | | | 88 | | | C8 | |
| PRT2DM1 | 09 | RW | | 49 | | | 89 | | | C9 | |
| PRT2IC0 | 0A | RW | | 4A | | | 8A | | | CA | |
| PRT2IC1 | 0B | RW | | 4B | | | 8B | | | CB | |
| | 0C | | | 4C | | | 8C | | | CC | |
| | 0D | | | 4D | | | 8D | | | CD | |
| | 0E | | | 4E | | | 8E | | | CE | |
| | 0F | | | 4F | | | 8F | | | CF | |
| | 10 | | | 50 | | | 90 | | GDI_O_IN | D0 | RW |
| | 11 | | | 51 | | | 91 | | GDI_E_IN | D1 | RW |
| | 12 | | | 52 | | | 92 | | GDI_O_OU | D2 | RW |
| | 13 | | | 53 | | | 93 | | GDI_E_OU | D3 | RW |
| | 14 | | | 54 | | | 94 | | | D4 | |
| | 15 | | | 55 | | | 95 | | | D5 | |
| | 16 | | | 56 | | | 96 | | | D6 | |
| | 17 | | | 57 | | | 97 | | | D7 | |
| | 18 | | | 58 | | | 98 | | MUX_CR0 | D8 | RW |
| | 19 | | | 59 | | | 99 | | MUX_CR1 | D9 | RW |
| | 1A | | | 5A | | | 9A | | MUX_CR2 | DA | RW |
| | 1B | | | 5B | | | 9B | | MUX_CR3 | DB | RW |
| | 1C | | | 5C | | | 9C | | | DC | |
| | 1D | | | 5D | | | 9D | | OSC_GO_EN | DD | RW |
| | 1E | | | 5E | | | 9E | | OSC_CR4 | DE | RW |
| | 1F | | | 5F | | | 9F | | OSC_CR3 | DF | RW |
| DBB00FN | 20 | RW | CLK_CR0 | 60 | RW | | A0 | | OSC_CR0 | E0 | RW |
| DBB00IN | 21 | RW | CLK_CR1 | 61 | RW | | A1 | | OSC_CR1 | E1 | RW |
| DBB00OU | 22 | RW | ABF_CR0 | 62 | RW | | A2 | | OSC_CR2 | E2 | RW |
| | 23 | | AMD_CR0 | 63 | RW | | A3 | | VLT_CR | E3 | RW |
| DBB01FN | 24 | RW | CMP_GO_EN | 64 | RW | | A4 | | VLT_CMP | E4 | R |
| DBB01IN | 25 | RW | | 65 | | | A5 | | ADC0_TR | E5 | RW |
| DBB01OU | 26 | RW | AMD_CR1 | 66 | RW | | A6 | | ADC1_TR | E6 | RW |
| | 27 | | ALT_CR0 | 67 | RW | | A7 | | | E7 | |
| DCB02FN | 28 | RW | | 68 | | | A8 | | IMO_TR | E8 | W |
| DCB02IN | 29 | RW | | 69 | | | A9 | | ILO_TR | E9 | W |
| DCB02OU | 2A | RW | | 6A | | | AA | | BDG_TR | EA | RW |
| | 2B | | CLK_CR3 | 6B | RW | | AB | | ECO_TR | EB | W |
| DCB03FN | 2C | RW | TMP_DR0 | 6C | RW | | AC | | | EC | |
| DCB03IN | 2D | RW | TMP_DR1 | 6D | RW | | AD | | | ED | |
| DCB03OU | 2E | RW | TMP_DR2 | 6E | RW | | AE | | | EE | |
| | 2F | | TMP_DR3 | 6F | RW | | AF | | | EF | |
| | 30 | | | 70 | | RDI0RI | B0 | RW | | F0 | |
| | 31 | | | 71 | | RDI0SYN | B1 | RW | | F1 | |
| | 32 | | ACE00CR1 | 72 | RW | RDI0IS | B2 | RW | | F2 | |
| | 33 | | ACE00CR2 | 73 | RW | RDI0LT0 | B3 | RW | | F3 | |
| | 34 | | | 74 | | RDI0LT1 | B4 | RW | | F4 | |
| | 35 | | | 75 | | RDI0RO0 | B5 | RW | | F5 | |
| | 36 | | ACE01CR1 | 76 | RW | RDI0RO1 | B6 | RW | | F6 | |
| | 37 | | ACE01CR2 | 77 | RW | | B7 | | CPU_F | F7 | RL |
| | 38 | | | 78 | | | B8 | | | F8 | |
| | 39 | | | 79 | | | B9 | | | F9 | |
| | 3A | | | 7A | | | BA | | | FA | |
| | 3B | | | 7B | | | BB | | | FB | |
| | 3C | | | 7C | | | BC | | | FC | |
| | 3D | | | 7D | | | BD | | DAC_CR | FD | RW |
| | 3E | | | 7E | | | BE | | CPU_SCR1 | FE | # |
| | 3F | | | 7F | | | BF | | CPU_SCR0 | FF | # |

Blank fields are Reserved and must not be accessed.

Access is bit specific.

Electrical Specifications

This section presents the DC and AC electrical specifications of the automotive CY8C21x34 PSoC device. For the most up to date electrical specifications, confirm that you have the most recent datasheet by going to the web at <http://www.cypress.com>.

Specifications are valid for $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$ and $T_J \leq 135\text{ }^{\circ}\text{C}$ as specified, except where noted. Refer to [Table 15 on page 18](#) for the electrical specifications for the IMO using slow IMO (SLIMO) mode.

Figure 5. Voltage versus CPU Frequency

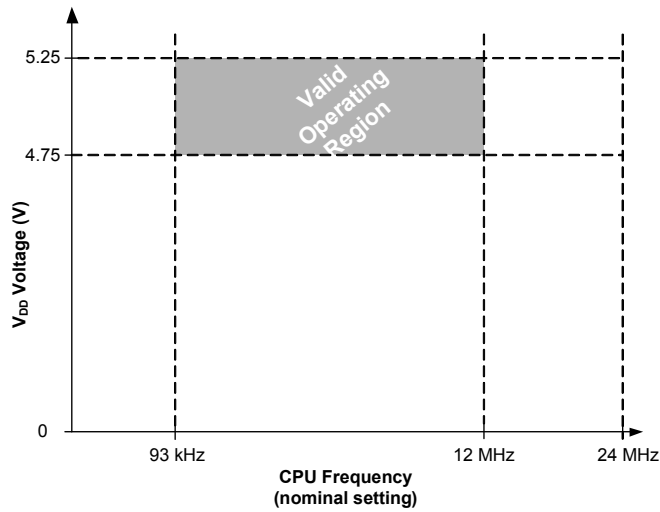
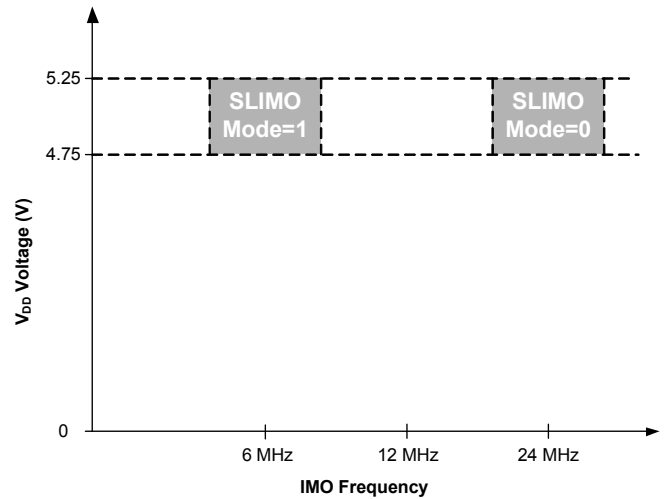


Figure 6. IMO Frequency Trim Options





Absolute Maximum Ratings

Exceeding maximum ratings may shorten the useful life of the device. User guidelines are not tested.

Table 7. Absolute Maximum Ratings

| Symbol | Description | Min | Typ | Max | Units | Notes |
|-----------------------|---|-----------------------|-----|-----------------------|-------|--|
| T _{STG} | Storage temperature | -55 | +25 | +125 | °C | Higher storage temperatures reduce data retention time. Recommended storage temperature is +25 °C ± 25 °C. Time spent in storage at a temperature greater than 65 °C counts toward the Flash _{DR} electrical specification in Table 14 on page 17 . Maximum combined storage and operational time at +125 °C is 7000 hours. |
| T _{BAKETEMP} | Bake temperature | - | 125 | See package label | °C | |
| t _{BAKETIME} | Bake time | See package label | - | 72 | Hours | |
| T _A | Ambient temperature with power applied | -40 | - | +125 | °C | |
| V _{DD} | Supply voltage on V _{DD} relative to V _{SS} | -0.5 | - | +6.0 | V | |
| V _{IO} | DC input voltage | V _{SS} - 0.5 | - | V _{DD} + 0.5 | V | |
| V _{IOZ} | DC voltage applied to tristate | V _{SS} - 0.5 | - | V _{DD} + 0.5 | V | |
| I _{MIO} | Maximum current into any port pin | -25 | - | +50 | mA | |
| ESD | Electrostatic discharge (ESD) voltage | 2000 | - | - | V | Human body model ESD. |
| LU | Latch-up current | - | - | 200 | mA | |

Operating Temperature

Table 8. Operating Temperature

| Symbol | Description | Min | Typ | Max | Units | Notes |
|----------------|----------------------|-----|-----|------|-------|---|
| T _A | Ambient temperature | -40 | - | +125 | °C | |
| T _J | Junction temperature | -40 | - | +135 | °C | The temperature rise from ambient to junction is package specific. See Table 22 on page 24 . The user must limit the power consumption to comply with this requirement. |



DC Electrical Characteristics

DC Chip-Level Specifications

Table 9 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 9. DC Chip-Level Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|------------------|---|------|------|------|-------|---|
| V _{DD} | Supply voltage | 4.75 | – | 5.25 | V | See Table 13 on page 16. |
| I _{DD} | Supply current, I _{MO} = 24 MHz | – | 4 | 8 | mA | Conditions are V _{DD} = 5.25 V, $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$, CPU = 3 MHz, 48 MHz disabled. VC1 = 1.5 MHz, VC2 = 93.75 kHz, VC3 = 0.366 kHz. |
| I _{SB} | Sleep (mode) current with POR, LVD, sleep timer, WDT, and ILO active. Mid temperature range. | – | 5 | 12 | μA | V _{DD} = 5.25 V, $-40\text{ }^{\circ}\text{C} \leq T_A \leq 55\text{ }^{\circ}\text{C}$. |
| I _{SBH} | Sleep (mode) current with POR, LVD, sleep timer, WDT, and ILO active. High temperature range. | – | 5 | 100 | μA | V _{DD} = 5.25 V, $55\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. |
| V _{REF} | Reference voltage (Bandgap) | 1.25 | 1.30 | 1.35 | V | |

DC GPIO Specifications

Table 10 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 10. DC GPIO Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|------------------|-----------------------------------|-----|-----|------|-------|---|
| R _{PU} | Pull-up resistor | 4 | 5.6 | 8 | kΩ | |
| R _{PD} | Pull-down resistor | 4 | 5.6 | 8 | kΩ | Also applies to the internal pull-down resistor on the XRES pin |
| V _{OH} | High output level | 3.5 | – | – | V | I _{OH} = 10 mA, V _{DD} = 4.75 to 5.25 V (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). |
| V _{OL} | Low output level | – | – | 0.75 | V | I _{OL} = 25 mA, V _{DD} = 4.75 to 5.25 V (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). |
| I _{OH} | High level source current | 10 | – | – | mA | V _{OH} ≥ V _{DD} – 1.0 V, see the limitations of the total current in the note for V _{OH} . |
| I _{OL} | Low level sink current | 25 | – | – | mA | V _{OL} ≤ 0.75 V, see the limitations of the total current in the note for V _{OL} . |
| V _{IL} | Input low level | – | – | 0.8 | V | |
| V _{IH} | Input high level | 2.1 | – | – | V | |
| V _H | Input hysteresis | – | 60 | – | mV | |
| I _{IL} | Input leakage (absolute value) | – | 1 | – | nA | Gross tested to 1 μA. |
| C _{IN} | Capacitive load on pins as input | – | 3.5 | 10 | pF | Package and pin dependent. T _A = 25 °C. |
| C _{OUT} | Capacitive load on pins as output | – | 3.5 | 10 | pF | Package and pin dependent. T _A = 25 °C. |



DC Operational Amplifier Specifications

Table 11 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 11. DC Operational Amplifier Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|------------------|--|-----|-----|--------------|--------------------------------|--|
| V_{OSOA} | Input offset voltage (absolute value) | – | 2.5 | 15 | mV | |
| TCV_{OSOA} | Average input offset voltage drift | – | 10 | – | $\mu\text{V}/^{\circ}\text{C}$ | |
| $I_{EBOA}^{[6]}$ | Input leakage current (Port 0 analog pins) | – | 200 | – | pA | Gross tested to 1 μA . |
| C_{INOA} | Input capacitance (Port 0 analog pins) | – | 4.5 | 9.5 | pF | Package and pin dependent. $T_A = 25\text{ }^{\circ}\text{C}$. |
| V_{CMOA} | Common mode voltage range | 0.0 | – | $V_{DD} - 1$ | V | |
| G_{OLOA} | Open loop gain | – | 80 | – | dB | |
| I_{SOA} | Amplifier supply current | – | 10 | 100 | μA | |

DC Analog Mux Bus Specifications

Table 12 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 12. DC Analog Mux Bus Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|-----------|---|-----|-----|-----|----------|-------|
| R_{SW} | Switch resistance to common analog bus | – | – | 400 | Ω | |
| RV_{DD} | Resistance of initialization switch to V_{DD} | – | – | 800 | Ω | |

DC POR and LVD Specifications

Table 13 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 13. DC POR and LVD Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|-------------|---|------|------|---------------------|-------|--|
| V_{PPOR0} | V_{DD} value for PPOR trip PORLEV[1:0] = 00b | – | 2.36 | 2.40 | V | V_{DD} must be greater than or equal to 2.5 V during startup, reset from the XRES pin, or reset from watchdog. |
| V_{PPOR1} | PORLEV[1:0] = 01b | – | 2.82 | 2.95 | V | |
| V_{PPOR2} | PORLEV[1:0] = 10b | – | 4.55 | 4.70 | V | |
| V_{LVD0} | V_{DD} value for LVD trip VM[2:0] = 000b | 2.40 | 2.45 | 2.51 ^[7] | V | |
| V_{LVD1} | VM[2:0] = 001b | 2.85 | 2.92 | 2.99 ^[8] | V | |
| V_{LVD2} | VM[2:0] = 010b | 2.95 | 3.02 | 3.09 | V | |
| V_{LVD3} | VM[2:0] = 011b | 3.06 | 3.13 | 3.20 | V | |
| V_{LVD4} | VM[2:0] = 100b | 4.37 | 4.48 | 4.55 | V | |
| V_{LVD5} | VM[2:0] = 101b | 4.50 | 4.64 | 4.75 | V | |
| V_{LVD6} | VM[2:0] = 110b | 4.62 | 4.73 | 4.83 | V | |
| V_{LVD7} | VM[2:0] = 111b | 4.71 | 4.81 | 4.95 | V | |

Notes

- Atypical behavior: I_{EBOA} of Port 0 Pin 0 is below 1 nA at 25 °C; 50 nA over temperature. Use Port 0 Pins 1-7 for the lowest leakage of 200 pA.
- Always greater than 50 mV above V_{PPOR0} (PORLEV[1:0] = 00b) for falling supply.
- Always greater than 50 mV above V_{PPOR1} (PORLEV[1:0] = 01b) for falling supply.



DC Programming Specifications

Table 14 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 14. DC Programming Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|-----------------------|---|--------|-----|-----------------|-------|--|
| V _{DDP} | V _{DD} for programming and erase | 4.5 | 5 | 5.5 | V | This specification applies to the functional requirements of external programmer tools |
| V _{DDL} | Low V _{DD} for verify | 4.7 | 4.8 | 4.9 | V | This specification applies to the functional requirements of external programmer tools |
| V _{DDH} | High V _{DD} for verify | 5.1 | 5.2 | 5.3 | V | This specification applies to the functional requirements of external programmer tools |
| V _{DDIWRITE} | Supply voltage for flash write operation | 4.75 | 5.0 | 5.25 | V | This specification applies to this device when it is executing internal flash writes |
| I _{DDP} | Supply current during programming or verify | – | 5 | 25 | mA | |
| V _{ILP} | Input low voltage during programming or verify | – | – | 0.8 | V | |
| V _{IHP} | Input high voltage during programming or verify | 2.2 | – | – | V | |
| I _{ILP} | Input current when applying V _{ILP} to P1[0] or P1[1] during programming or verify | – | – | 0.2 | mA | Driving internal pull-down resistor. |
| I _{IHP} | Input current when applying V _{IHP} to P1[0] or P1[1] during programming or verify | – | – | 1.5 | mA | Driving internal pull-down resistor. |
| V _{OLV} | Output low voltage during programming or verify | – | – | 0.75 | V | |
| V _{OHV} | Output high voltage during programming or verify | 3.5 | – | V _{DD} | V | |
| Flash _{ENPB} | Flash endurance (per block) ^[9] | 100 | – | – | – | Erase/write cycles per block. |
| Flash _{ENT} | Flash endurance (total) ^[9, 10] | 12,800 | – | – | – | Erase/write cycles. |
| Flash _{DR} | Flash data retention ^[11] | 15 | – | – | Years | |

Notes

9. For the full temperature range, the user must employ a temperature sensor user module (FlashTemp) or other temperature sensor, and feed the result to the temperature argument before writing. Refer to the Flash APIs [Application Note AN2015](#) for more information.

10. The maximum total number of allowed erase/write cycles is the minimum Flash_{ENPB} value multiplied by the number of flash blocks in the device.

11. Flash data retention based on the use condition of ≤ 7000 hours at $T_A \leq 125\text{ }^{\circ}\text{C}$ and the remaining time at $T_A \leq 65\text{ }^{\circ}\text{C}$.



AC Electrical Characteristics

AC Chip-Level Specifications

Table 15 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 15. AC Chip-Level Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|--------------------------------------|--|----------------------|-----|----------------------|-------|---|
| F _{IMO24} | IMO frequency for 24 MHz | 22.8 ^[12] | 24 | 25.2 ^[12] | MHz | Trimmed using factory trim values. See Figure 6 on page 13. SLIMO mode = 0. |
| F _{IMO6} | IMO frequency for 6 MHz | 5.5 ^[12] | 6 | 6.5 ^[12] | MHz | Trimmed using factory trim values. See Figure 6 on page 13. SLIMO mode = 1. |
| F _{CPU1} | CPU frequency (5 V V _{DD} nominal) | 0.09 ^[12] | 12 | 12.6 ^[12] | MHz | SLIMO mode = 0. |
| F _{BLK5} | Digital PSoC block frequency (5 V V _{DD} nominal) | 0 | 24 | 25.2 ^[12] | MHz | Refer to Table 18 on page 20. |
| F _{32K1} | ILO frequency | 15 | 32 | 64 | kHz | This specification applies when the ILO has been trimmed. |
| F _{32KU} | ILO untrimmed frequency | 5 | – | 100 | kHz | After a reset and before the M8C processor starts to execute, the ILO is not trimmed. |
| t _{XRST} | External reset pulse width | 10 | – | – | μs | |
| DC _{24M} | 24 MHz duty cycle | 40 | 50 | 60 | % | |
| DC _{ILO} | ILO duty cycle | 20 | 50 | 80 | % | |
| Step _{24M} | 24 MHz trim step size | – | 50 | – | kHz | |
| F _{MAX} | Maximum frequency of signal on row input or row output. | – | – | 12.6 ^[12] | MHz | |
| SR _{POWERUP} | Power supply slew rate | – | – | 250 | V/ms | V _{DD} slew rate during power up. |
| t _{POWERUP} | Time between end of POR state and CPU code execution | – | 16 | 100 | ms | Power-up from 0 V. |
| t _{JIT_IMO} ^[13] | 24 MHz IMO cycle-to-cycle jitter (RMS) | – | 200 | 700 | ps | N = 32 |
| | 24 MHz IMO long term N cycle-to-cycle jitter (RMS) | – | 300 | 900 | | |
| | 24 MHz IMO period jitter (RMS) | – | 100 | 400 | | |

Notes

12. Accuracy derived from Internal Main Oscillator with appropriate trim for V_{DD} range.

13. Refer to Cypress Jitter Specifications document, [Understanding Datasheet Jitter Specifications for Cypress Timing Products](#), for more information.



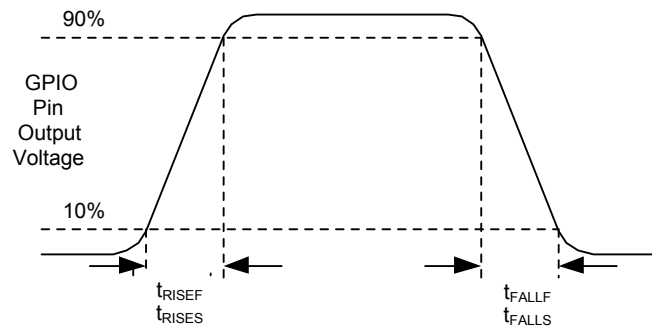
AC GPIO Specifications

Table 16 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 16. AC GPIO Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|--------------------|---|-----|-----|----------------------|-------|--------------------|
| F_{GPIO} | GPIO operating frequency | 0 | – | 12.6 ^[14] | MHz | Normal Strong Mode |
| t_{RISEF} | Rise time, normal strong mode, Clload = 50 pF | 2 | – | 22 | ns | 10% to 90% |
| t_{FALLF} | Fall time, normal strong mode, Clload = 50 pF | 2 | – | 22 | ns | 10% to 90% |
| t_{RISES} | Rise time, slow strong mode, Clload = 50 pF | 7 | 27 | – | ns | 10% to 90% |
| t_{FALLS} | Fall time, slow strong mode, Clload = 50 pF | 7 | 22 | – | ns | 10% to 90% |

Figure 7. GPIO Timing Diagram



AC Operational Amplifier Specifications

Table 17 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 17. AC Operational Amplifier Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|-------------------|--|-----|-----|-----|-------|-------|
| t_{COMP} | Comparator mode response time, 50 mV overdrive | – | – | 150 | ns | |

Note

14. Accuracy derived from Internal Main Oscillator with appropriate trim for V_{DD} range.



AC Digital Block Specifications

Table 18 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 18. AC Digital Block Specifications

| Function | Description | Min | Typ | Max | Units | Notes |
|-------------------|--|--------------------|-----|----------------------|-------|---|
| All functions | Block input clock frequency | – | – | 25.2 ^[16] | MHz | |
| Timer | Input clock frequency | | | | | |
| | No capture | – | – | 25.2 ^[16] | MHz | |
| | With capture | – | – | 25.2 ^[16] | MHz | |
| | Capture pulse width | 50 ^[15] | – | – | ns | |
| Counter | Input clock frequency | | | | | |
| | No enable input | – | – | 25.2 ^[16] | MHz | |
| | With enable input | – | – | 25.2 ^[16] | MHz | |
| | Enable input pulse width | 50 ^[15] | – | – | ns | |
| Dead Band | Kill pulse width | | | | | |
| | Asynchronous restart mode | 20 | – | – | ns | |
| | Synchronous restart mode | 50 ^[15] | – | – | ns | |
| | Disable mode | 50 ^[15] | – | – | ns | |
| | Input clock frequency | – | – | 25.2 ^[16] | MHz | |
| CRCPRS (PRS Mode) | Input clock frequency | – | – | 25.2 ^[16] | MHz | |
| CRCPRS (CRC Mode) | Input clock frequency | – | – | 25.2 ^[16] | MHz | |
| SPIM | Input clock frequency | – | – | 4.2 ^[16] | MHz | The SPI serial clock (SCLK) frequency is equal to the input clock frequency divided by 2. |
| SPIS | Input clock (SCLK) frequency | – | – | 2.1 ^[16] | MHz | The input clock is the SPI SCLK in SPIS mode. |
| | Width of SS_ negated between transmissions | 50 ^[15] | – | – | ns | |
| Transmitter | Input clock frequency | – | – | 8.4 ^[16] | MHz | The baud rate is equal to the input clock frequency divided by 8. |
| Receiver | Input clock frequency | – | – | 25.2 ^[16] | MHz | The baud rate is equal to the input clock frequency divided by 8. |

Note

15. 50 ns minimum input pulse width is based on the input synchronizers running at 24 MHz (42 ns nominal period).

16. Accuracy derived from IMO with appropriate trim for V_{DD} range.



AC External Clock Specifications

Table 19 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 19. AC External Clock Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|---------------------|------------------------|-------|-----|-------|---------------|-------|
| F_{OSCEXT} | Frequency | 0.093 | – | 24.24 | MHz | |
| – | High period | 20.6 | – | 5300 | ns | |
| – | Low period | 20.6 | – | – | ns | |
| – | Power-up IMO to switch | 150 | – | – | μs | |

AC Programming Specifications

Table 20 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 20. AC Programming Specifications

| Symbol | Description | Min | Typ | Max | Units | Notes |
|---------------------|---|-----|-----|---------------------|-------|--------------------------------------|
| t_{RSCLK} | Rise time of SCLK | 1 | – | 20 | ns | |
| t_{FSCLK} | Fall time of SCLK | 1 | – | 20 | ns | |
| t_{SSCLK} | Data setup time to falling edge of SCLK | 40 | – | – | ns | |
| t_{HSCLK} | Data hold time from falling edge of SCLK | 40 | – | – | ns | |
| F_{SCLK} | Frequency of SCLK | 0 | – | 8 | MHz | |
| t_{ERASEB} | Flash erase time (block) | – | 10 | 40 ^[17] | ms | |
| t_{WRITE} | Flash block write time | – | 40 | 160 ^[17] | ms | |
| t_{DSCLK} | Data Out delay from falling edge of SCLK | – | – | 50 | ns | |
| t_{PRGH} | Total flash block program time ($t_{\text{ERASEB}} + t_{\text{WRITE}}$), hot | – | – | 100 ^[17] | ms | $T_J \geq 0\text{ }^{\circ}\text{C}$ |
| t_{PRGC} | Total flash block program time ($t_{\text{ERASEB}} + t_{\text{WRITE}}$), cold | – | – | 200 ^[17] | ms | $T_J < 0\text{ }^{\circ}\text{C}$ |

Note

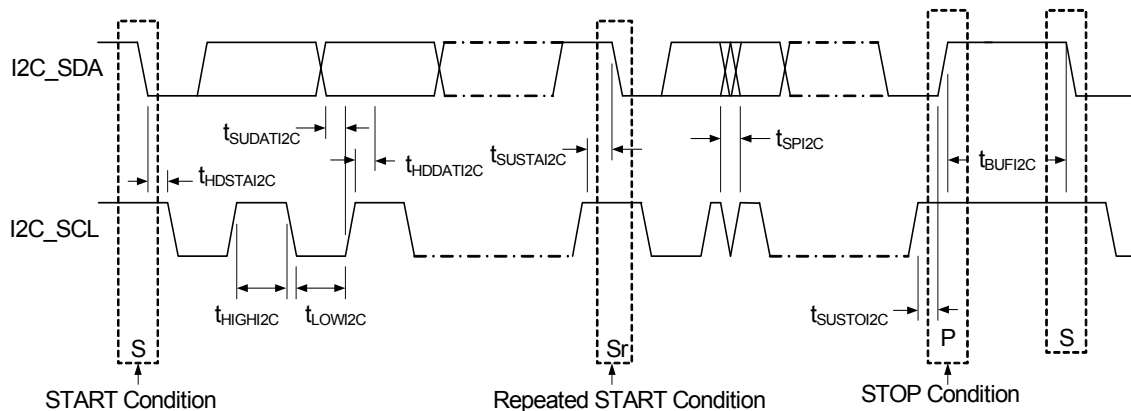
17. For the full temperature range, the user must employ a temperature sensor user module (FlashTemp) or other temperature sensor, and feed the result to the temperature argument before writing. Refer to the Flash APIs [Application Note AN2015](#) for more information.

AC I²C Specifications

Table 21 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$. Typical parameters apply to 5 V at 25 °C and are for design guidance only.

Table 21. AC Characteristics of the I²C SDA and SCL Pins

| Symbol | Description | Standard Mode | | Fast Mode | | Units | Notes |
|-----------------------|--|---------------|---------------------|---------------------|---------------------|-------|-------|
| | | Min | Max | Min | Max | | |
| F _{SCL I2C} | SCL clock frequency | 0 | 100 ^[18] | 0 | 400 ^[18] | kHz | |
| t _{HDSTAI2C} | Hold time (repeated) START condition. After this period, the first clock pulse is generated. | 4.0 | – | 0.6 | – | μs | |
| t _{LOW I2C} | LOW period of the SCL clock | 4.7 | – | 1.3 | – | μs | |
| t _{HIGH I2C} | HIGH period of the SCL clock | 4.0 | – | 0.6 | – | μs | |
| t _{SUSTAI2C} | Setup time for a repeated START condition | 4.7 | – | 0.6 | – | μs | |
| t _{HDDATI2C} | Data hold time | 0 | – | 0 | – | μs | |
| t _{SUDATI2C} | Data setup time | 250 | – | 100 ^[19] | – | ns | |
| t _{SUSTOI2C} | Setup time for STOP condition | 4.0 | – | 0.6 | – | μs | |
| t _{BUFI2C} | Bus free time between a STOP and START condition | 4.7 | – | 1.3 | – | μs | |
| t _{SPI2C} | Pulse width of spikes are suppressed by the input filter. | – | – | 0 | 50 | ns | |

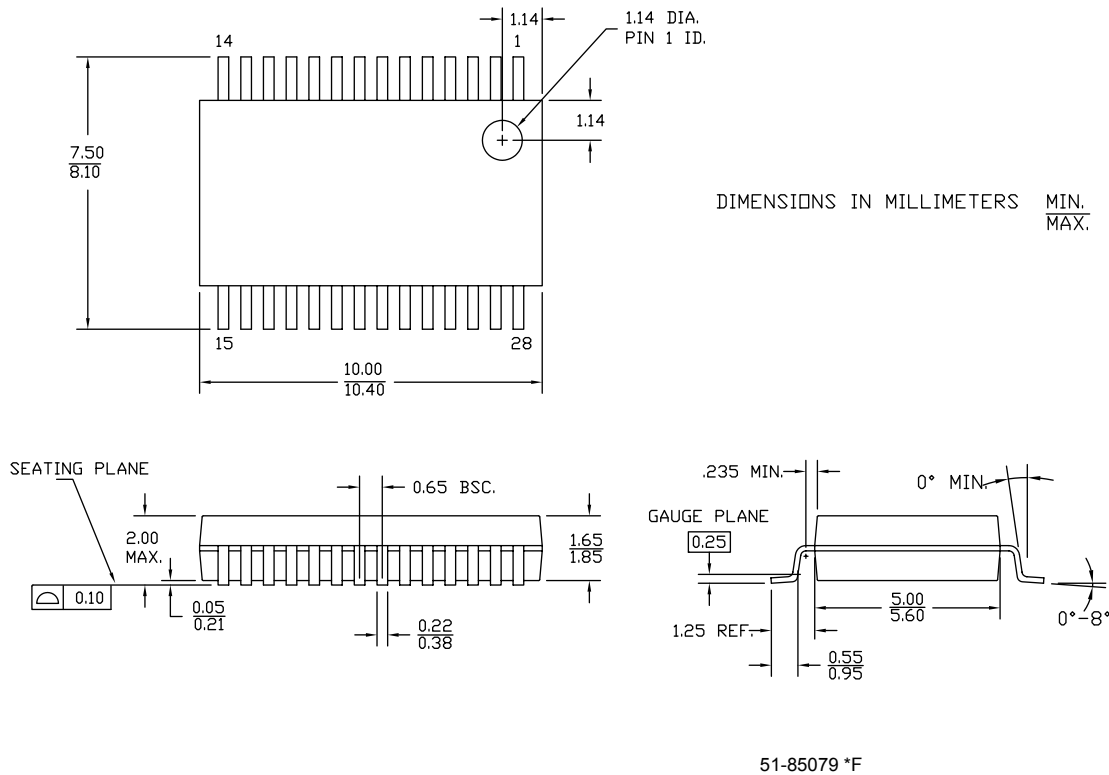
Figure 8. Definition for Timing for Fast/Standard Mode on the I²C Bus

Notes

18. F_{SCL I2C} is derived from SysClk of the PSoC. This specification assumes that SysClk is operating at 24 MHz, nominal. If SysClk is at a lower frequency, then the F_{SCL I2C} specification adjusts accordingly.

19. A Fast-Mode I²C-bus device can be used in a Standard-Mode I²C-bus system, but the requirement t_{SUDATI2C} ≥ 250 ns must then be met. This is automatically the case if the device does not stretch the LOW period of the SCL signal. If such device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line t_{rmax} + t_{SUDATI2C} = 1000 + 250 = 1250 ns (according to the Standard-Mode I²C-bus specification) before the SCL line is released.

Figure 10. 28-Pin SSOP (210 Mils)



Thermal Impedances

Table 22. Thermal Impedances per Package

| Package | Typical θ_{JA} ^[20] | Typical θ_{JC} |
|-------------|---------------------------------------|-----------------------|
| 20-pin SSOP | 117 °C/W | 41 °C/W |
| 28-pin SSOP | 96 °C/W | 39 °C/W |

Solder Reflow Specifications

Table 23 shows the solder reflow temperature limits that must not be exceeded.

Table 23. Solder Reflow Specifications

| Package | Maximum Peak Temperature (T_C) | Maximum Time above $T_C - 5$ °C |
|-------------|------------------------------------|---------------------------------|
| 20-pin SSOP | 260 °C | 30 seconds |
| 28-pin SSOP | 260 °C | 30 seconds |

Note

$$20. T_J = T_A + \text{Power} \times \theta_{JA}$$



Development Tool Selection

This section presents the development tools available for the automotive CY8C21x34 family.

Software

PSoC Designer

At the core of the PSoC development software suite is PSoC Designer. Utilized by thousands of PSoC developers, this robust software has been facilitating PSoC designs for years. PSoC Designer is available free of charge at <http://www.cypress.com>. PSoC Designer comes with a free C compiler.

PSoC Programmer

Flexible enough to be used on the bench in development, yet suitable for factory programming, PSoC Programmer works either as a standalone programming application or it can operate directly from PSoC Designer. PSoC Programmer software is compatible with both PSoC ICE-Cube in-circuit emulator and PSoC MiniProg. PSoC programmer is available free of charge at <http://www.cypress.com>.

Development Kits

All development kits can be purchased from the [Cypress Online Store](#). The online store also has the most up to date information on kit contents, descriptions, and availability.

CY3215-DK Basic Development Kit

The **CY3215-DK** is for prototyping and development with PSoC Designer. This kit supports in-circuit emulation and the software interface allows users to run, halt, and single step the processor and view the contents of specific memory locations. Advanced emulation features are also supported through PSoC Designer. The kit includes:

- ICE-Cube Unit
- 28-Pin PDIP Emulation Pod for CY8C29466-24PXI
- 28-Pin CY8C29466-24PXI PDIP PSoC Device Samples (two)
- PSoC Designer Software CD
- ISSP Cable
- MiniEval Socket Programming and Evaluation board
- Backward Compatibility Cable (for connecting to legacy Pods)
- Universal 110/220 Power Supply (12 V)
- European Plug Adapter
- USB 2.0 Cable
- Getting Started Guide
- Development Kit Registration form

CY3280-BK1

The **CY3280-BK1** Universal CapSense Control Kit is designed for easy prototyping and debug of CapSense designs with

pre-defined control circuitry and plug-in hardware. The kit comes with a control boards for CY8C20x34 and CY8C21x34 devices as well as a breadboard module and a button(5)/slider module.

Evaluation Tools

All evaluation tools can be purchased from the [Cypress Online Store](#). The online store also has the most up to date information on kit contents, descriptions, and availability.

CY3210-PSoCEval1

The **CY3210-PSoCEval1** kit features an evaluation board and the MiniProg1 programming unit. The evaluation board includes an LCD module, potentiometer, LEDs, an RS-232 port, and plenty of breadboarding space to meet all of your evaluation needs. The kit includes:

- Evaluation Board with LCD Module
- MiniProg Programming Unit
- 28-Pin CY8C29466-24PXI PDIP PSoC Device Sample (2)
- PSoC Designer Software CD
- Getting Started Guide
- USB 2.0 Cable

CY3235-ProxDet

The **CY3235-ProxDet** CapSense Proximity Detection Demonstration Kit allows quick and easy demonstration of a PSoC CapSense-enabled device (CY8C21x34) to accurately sense the proximity of a hand or finger along the length of a wire antenna. The kit includes:

- Proximity Detection Demo Board w/Antenna
- I2C to USB Debugging/Communication Bridge
- USB Cable (6 feet)
- Supporting Software CD
- CY3235-ProxDet Quick Start Guide
- 1 CY8C24894 PSoC device on I2C-USB Bridge
- 1 CY8C21434 PSoC device on Proximity Detection Demo Board

CY3210-21X34 Evaluation Pod (EvalPod)

PSoC EvalPods are pods that connect to the ICE In-Circuit Emulator (CY3215-DK kit) to allow debugging capability. They can also function as a standalone device without debugging capability. The EvalPod has a 28-pin DIP footprint on the bottom for easy connection to development kits or other hardware. The top of the EvalPod has prototyping headers for easy connection to the device's pins. **CY3210-21X34** provides evaluation of the CY8C21x34 PSoC device family.



Device Programmers

All device programmers can be purchased from the [Cypress Online Store](#). The online store also has the most up to date information on kit contents, descriptions, and availability.

CY3210-MiniProg1

The [CY3210-MiniProg1](#) kit allows a user to program PSoC devices via the MiniProg1 programming unit. The MiniProg is a small, compact prototyping programmer that connects to the PC via a provided USB 2.0 cable. The kit includes:

- MiniProg Programming Unit
- MiniEval Socket Programming and Evaluation Board
- 28-Pin CY8C29466-24PXI PDIP PSoC Device Sample
- PSoC Designer Software CD
- Getting Started Guide

- USB 2.0 Cable

CY3207ISSP In-System Serial Programmer (ISSP)

The [CY3207ISSP](#) is a production programmer. It includes protection circuitry and an industrial case that is more robust than the MiniProg in a production-programming environment.

Note: CY3207ISSP needs special software and is not compatible with PSoC Programmer. This software is free and can be downloaded from <http://www.cypress.com>. The kit includes:

- CY3207 Programmer Unit
- PSoC ISSP Software CD
- 110 ~ 240 V Power Supply, Euro-Plug Adapter
- USB 2.0 Cable

Accessories (Emulation and Programming)

Table 25. Emulation and Programming Accessories

| Part Number | Pin Package | Pod Kit ^[21] | Foot Kit ^[22] | Adapter ^[23] |
|------------------|-------------|------------------------------|----------------------------------|--|
| CY8C21334-12PVXE | 20-pin SSOP | CY3250-21X34 | CY3250-20SSOP-FK | Adapters can be found at http://www.emulation.com . |
| CY8C21534-12PVXE | 28-pin SSOP | CY3250-21X34 | CY3250-28SSOP-FK | |

Notes

21. Pod kit contains an emulation pod, a flex-cable (connects the pod to the ICE), two feet, and device samples.

22. Foot kit includes surface mount feet that can be soldered to the target PCB.

23. Programming adapter converts non-DIP package to DIP footprint. Specific details and ordering information for each of the adapters can be found at <http://www.emulation.com>.



Ordering Information

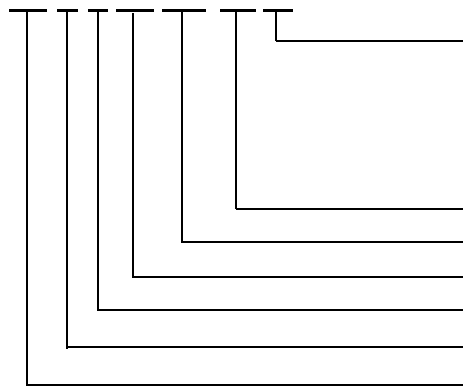
The following table lists the automotive CY8C21x34 PSoC device's key package features and ordering codes.

Table 26. PSoC Device Key Features and Ordering Information

| Package | Ordering Code | Flash (Bytes) | SRAM (Bytes) | Temperature Range | Digital Blocks | Analog Blocks | Digital I/O Pins | Analog Inputs | Analog Outputs | XRES Pin |
|---------------------------------------|-------------------|---------------|--------------|-------------------|----------------|---------------|------------------|---------------|----------------|----------|
| 20-pin (210-Mil) SSOP | CY8C21334-12PVXE | 8 K | 512 | -40 °C to +125 °C | 4 | 4 | 16 | 16 | 0 | Yes |
| 20-pin (210-Mil) SSOP (tape and reel) | CY8C21334-12PVXET | 8 K | 512 | -40 °C to +125 °C | 4 | 4 | 16 | 16 | 0 | Yes |
| 28-pin (210-Mil) SSOP | CY8C21534-12PVXE | 8 K | 512 | -40 °C to +125 °C | 4 | 4 | 24 | 24 | 0 | Yes |
| 28-pin (210-Mil) SSOP (tape and reel) | CY8C21534-12PVXET | 8 K | 512 | -40 °C to +125 °C | 4 | 4 | 24 | 24 | 0 | Yes |

Ordering Code Definitions

CY 8 C 21 xxx-12xx



Package Type:

PX = PDIP Pb-free
 SX = SOIC Pb-free
 PVX = SSOP Pb-free
 LFX = QFN Pb-free
 AX = TQFP Pb-free

CPU Speed: 12 MHz

Part Number

Family Code

Technology Code: C = CMOS

Marketing Code: 8 = PSoC

Company ID: CY = Cypress

Thermal Rating:

A = Automotive -40 °C to +85 °C
 C = Commercial
 I = Industrial
 E = Automotive Extended -40 °C to +125 °C



Acronyms

The following table lists the acronyms that are used in this document.

| Acronym | Description | Acronym | Description |
|---------|---|------------|---|
| AC | alternating current | MCU | microcontroller unit |
| ADC | analog-to-digital converter | MIPS | million instructions per second |
| API | application programming interface | PLL | phase-locked loop |
| AEC | Automotive Electronics Council | PDIP | plastic dual in-line package |
| CPU | central processing unit | POR | power-on reset |
| CT | continuous time | PPOR | precision POR |
| CRC | cyclic redundancy check | PCB | printed circuit board |
| DAC | digital-to-analog converter | PSoC® | Programmable System-on-Chip |
| DC | direct current or duty cycle | PRS | pseudo-random sequence |
| EEPROM | electrically erasable programmable read-only memory | PWM | pulse-width modulator |
| EXTCLK | external clock | SCL / SCLK | serial clock |
| XRES | external reset | SDA | serial data |
| GPIO | general-purpose I/O | SPI | serial peripheral interface |
| ICE | in-circuit emulator | SSOP | shrink small-outline package |
| IrDA | Infrared Data Association | SLIMO | slow IMO |
| I/O | input/output | SOIC | small-outline integrated circuit |
| ISSP | in-system serial programming | SRAM | static random-access memory |
| IDE | integrated development environment | SROM | supervisory read-only memory |
| I2C | Inter-Integrated Circuit | SMP | switch mode pump |
| ILO | internal low-speed oscillator | SC | switched capacitor |
| IMO | internal main oscillator | TQFP | thin quad flat pack |
| LED | light-emitting diode | UART | universal asynchronous receiver transmitter |
| LCD | liquid crystal display | USB | universal serial bus |
| LVD | low voltage detect | WDT | watchdog timer |

Reference Documents

[CY8CPLC20](#), [CY8CLED16P01](#), [CY8C29x66](#), [CY8C27x43](#), [CY8C24x94](#), [CY8C24x23](#), [CY8C24x23A](#), [CY8C22x13](#), [CY8C21x34](#), [CY8C21x23](#), [CY7C64215](#), [CY7C603xx](#), [CY8CNP1xx](#), and [CYWUSB6953](#) [PSoC® Programmable System-on-Chip Technical Reference Manual \(TRM\)](#) (001-14463)

[Design Aids – Reading and Writing PSoC® Flash – AN2015](#) (001-40459)

[Understanding Datasheet Jitter Specifications for Cypress Timing Products](#)



Document Conventions

Units of Measure

The following table lists the units of measure that are used in this document.

| Symbol | Unit of Measure | Symbol | Unit of Measure |
|--------|-----------------|--------|-----------------|
| °C | degree Celsius | ms | millisecond |
| dB | decibel | mV | millivolt |
| KB | 1024 bytes | nA | nanoampere |
| Kbit | 1024 bits | ns | nanosecond |
| kHz | kilohertz | W | ohm |
| kΩ | kilohm | pA | picoampere |
| MHz | megahertz | pF | picofarad |
| μA | microampere | ps | picosecond |
| μs | microsecond | V | volt |
| μV | microvolt | W | watt |
| mA | milliampere | | |

Numeric Conventions

Hexadecimal numbers are represented with all letters in uppercase with an appended lowercase 'h' (for example, '14h' or '3Ah'). Hexadecimal numbers may also be represented by a '0x' prefix, the C coding convention. Binary numbers have an appended lowercase 'b' (for example, '01010100b' or '01000011b'). Numbers not indicated by an 'h', 'b', or '0x' are in decimal format.

Glossary

| | |
|---|--|
| active high | <ol style="list-style-type: none"> 1. A logic signal having its asserted state as the logic 1 state. 2. A logic signal having the logic 1 state as the higher voltage of the two states. |
| analog blocks | The basic programmable Opamp circuits. These are SC (switched capacitor) and CT (continuous time) blocks. These blocks can be interconnected to provide ADCs, DACs, multi-pole filters, gain stages, and much more. |
| analog-to-digital converter (ADC) | A device that changes an analog signal to a digital signal of corresponding magnitude. Typically, an ADC converts a voltage to a digital number. The digital-to-analog converter (DAC) performs the reverse operation. |
| Application programming interface (API) | A series of software routines that comprise an interface between a computer application and lower level services and functions (for example, user modules and libraries). APIs serve as building blocks for programmers that create software applications. |
| asynchronous | A signal whose data is acknowledged or acted upon immediately, irrespective of any clock signal. |
| bandgap reference | A stable voltage reference design that matches the positive temperature coefficient of V_T with the negative temperature coefficient of V_{BE} , to produce a zero temperature coefficient (ideally) reference. |
| bandwidth | <ol style="list-style-type: none"> 1. The frequency range of a message or information processing system measured in hertz. 2. The width of the spectral region over which an amplifier (or absorber) has substantial gain (or loss); it is sometimes represented more specifically as, for example, full width at half maximum. |
| bias | <ol style="list-style-type: none"> 1. A systematic deviation of a value from a reference value. 2. The amount by which the average of a set of values departs from a reference value. 3. The electrical, mechanical, magnetic, or other force (field) applied to a device to establish a reference level to operate the device. |

Glossary (continued)

| | |
|-----------------------------------|---|
| block | <ol style="list-style-type: none"> 1. A functional unit that performs a single function, such as an oscillator. 2. A functional unit that may be configured to perform one of several functions, such as a digital PSoC block or an analog PSoC block. |
| buffer | <ol style="list-style-type: none"> 1. A storage area for data that is used to compensate for a speed difference, when transferring data from one device to another. Usually refers to an area reserved for I/O operations, into which data is read, or from which data is written. 2. A portion of memory set aside to store data, often before it is sent to an external device or as it is received from an external device. 3. An amplifier used to lower the output impedance of a system. |
| bus | <ol style="list-style-type: none"> 1. A named connection of nets. Bundling nets together in a bus makes it easier to route nets with similar routing patterns. 2. A set of signals performing a common function and carrying similar data. Typically represented using vector notation; for example, address[7:0]. 3. One or more conductors that serve as a common connection for a group of related devices. |
| clock | The device that generates a periodic signal with a fixed frequency and duty cycle. A clock is sometimes used to synchronize different logic blocks. |
| comparator | An electronic circuit that produces an output voltage or current whenever two input levels simultaneously satisfy predetermined amplitude requirements. |
| compiler | A program that translates a high level language, such as C, into machine language. |
| configuration space | In PSoC devices, the register space accessed when the XIO bit, in the CPU_F register, is set to '1'. |
| crystal oscillator | An oscillator in which the frequency is controlled by a piezoelectric crystal. Typically a piezoelectric crystal is less sensitive to ambient temperature than other circuit components. |
| cyclic redundancy check (CRC) | A calculation used to detect errors in data communications, typically performed using a linear feedback shift register. Similar calculations may be used for a variety of other purposes such as data compression. |
| data bus | A bi-directional set of signals used by a computer to convey information from a memory location to the central processing unit and vice versa. More generally, a set of signals used to convey data between digital functions. |
| debugger | A hardware and software system that allows you to analyze the operation of the system under development. A debugger usually allows the developer to step through the firmware one step at a time, set break points, and analyze memory. |
| dead band | A period of time when neither of two or more signals are in their active state or in transition. |
| digital blocks | The 8-bit logic blocks that can act as a counter, timer, serial receiver, serial transmitter, CRC generator, pseudo-random number generator, or SPI. |
| digital-to-analog converter (DAC) | A device that changes a digital signal to an analog signal of corresponding magnitude. The analog-to-digital converter (ADC) performs the reverse operation. |
| duty cycle | The relationship of a clock period high time to its low time, expressed as a percent. |
| emulator | Duplicates (provides an emulation of) the functions of one system with a different system, so that the second system appears to behave like the first system. |

Glossary (continued)

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| external reset (XRES) | An active high signal that is driven into the PSoC device. It causes all operation of the CPU and blocks to stop and return to a pre-defined state. |
| flash | An electrically programmable and erasable, non-volatile technology that provides you the programmability and data storage of EPROMs, plus in-system erasability. Non-volatile means that the data is retained when power is off. |
| flash block | The smallest amount of flash ROM space that may be programmed at one time and the smallest amount of flash space that may be protected. |
| frequency | The number of cycles or events per unit of time, for a periodic function. |
| gain | The ratio of output current, voltage, or power to input current, voltage, or power, respectively. Gain is usually expressed in dB. |
| I ² C | A two-wire serial computer bus by Phillips Semiconductors (now NXP Semiconductors). It is used to connect low-speed peripherals in an embedded system. The original system was created in the early 1980s as a battery control interface, but it was later used as a simple internal bus system for building control electronics. I ² C uses only two bi-directional pins, clock and data, both running at the V _{DD} supply voltage and pulled high with resistors. The bus operates up to 100 kbits/second in standard mode and 400 kbits/second in fast mode. |
| ICE | The in-circuit emulator that allows you to test the project in a hardware environment, while viewing the debugging device activity in a software environment (PSoC Designer). |
| input/output (I/O) | A device that introduces data into or extracts data from a system. |
| interrupt | A suspension of a process, such as the execution of a computer program, caused by an event external to that process, and performed in such a way that the process can be resumed. |
| interrupt service routine (ISR) | A block of code that normal code execution is diverted to when the CPU receives a hardware interrupt. Many interrupt sources may each exist with its own priority and individual ISR code block. Each ISR code block ends with the RETI instruction, returning the device to the point in the program where it left normal program execution. |
| jitter | <ol style="list-style-type: none"> 1. A misplacement of the timing of a transition from its ideal position. A typical form of corruption that occurs on serial data streams. 2. The abrupt and unwanted variations of one or more signal characteristics, such as the interval between successive pulses, the amplitude of successive cycles, or the frequency or phase of successive cycles. |
| low voltage detect (LVD) | A circuit that senses V _{DD} and provides an interrupt to the system when V _{DD} falls below a selected threshold. |
| M8C | An 8-bit Harvard-architecture microprocessor. The microprocessor coordinates all activity inside a PSoC by interfacing to the flash, SRAM, and register space. |
| master device | A device that controls the timing for data exchanges between two devices. Or when devices are cascaded in width, the master device is the one that controls the timing for data exchanges between the cascaded devices and an external interface. The controlled device is called the <i>slave device</i> . |
| microcontroller | An integrated circuit chip that is designed primarily for control systems and products. In addition to a CPU, a microcontroller typically includes memory, timing circuits, and I/O circuitry. The reason for this is to permit the realization of a controller with a minimal quantity of chips, thus achieving maximal possible miniaturization. This in turn, reduces the volume and the cost of the controller. The microcontroller is normally not used for general-purpose computation as is a microprocessor. |
| mixed-signal | The reference to a circuit containing both analog and digital techniques and components. |

Glossary (continued)

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| modulator | A device that imposes a signal on a carrier. |
| noise | <ol style="list-style-type: none"> 1. A disturbance that affects a signal and that may distort the information carried by the signal. 2. The random variations of one or more characteristics of any entity such as voltage, current, or data. |
| oscillator | A circuit that may be crystal controlled and is used to generate a clock frequency. |
| parity | A technique for testing transmitted data. Typically, a binary digit is added to the data to make the sum of all the digits of the binary data either always even (even parity) or always odd (odd parity). |
| phase-locked loop (PLL) | An electronic circuit that controls an <i>oscillator</i> so that it maintains a constant phase angle relative to a reference signal. |
| pinouts | The pin number assignment: the relation between the logical inputs and outputs of the PSoC device and their physical counterparts in the printed circuit board (PCB) package. Pinouts involve pin numbers as a link between schematic and PCB design (both being computer generated files) and may also involve pin names. |
| port | A group of pins, usually eight. |
| power-on reset (POR) | A circuit that forces the PSoC device to reset when the voltage is below a pre-set level. This is one type of hardware reset. |
| PSoC® | Cypress Semiconductor's PSoC® is a registered trademark and Programmable System-on-Chip™ is a trademark of Cypress. |
| PSoC Designer™ | The software for Cypress' Programmable System-on-Chip technology. |
| pulse width modulator (PWM) | An output in the form of duty cycle which varies as a function of the applied value. |
| RAM | An acronym for random access memory. A data-storage device from which data can be read out and new data can be written in. |
| register | A storage device with a specific capacity, such as a bit or byte. |
| reset | A means of bringing a system back to a known state. See hardware reset and software reset. |
| ROM | An acronym for read only memory. A data-storage device from which data can be read out, but new data cannot be written in. |
| serial | <ol style="list-style-type: none"> 1. Pertaining to a process in which all events occur one after the other. 2. Pertaining to the sequential or consecutive occurrence of two or more related activities in a single device or channel. |
| settling time | The time it takes for an output signal or value to stabilize after the input has changed from one value to another. |
| shift register | A memory storage device that sequentially shifts a word either left or right to output a stream of serial data. |
| slave device | A device that allows another device to control the timing for data exchanges between two devices. Or when devices are cascaded in width, the slave device is the one that allows another device to control the timing of data exchanges between the cascaded devices and an external interface. The controlling device is called the master device. |



Glossary (continued)

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| SRAM | An acronym for static random access memory. A memory device where you can store and retrieve data at a high rate of speed. The term static is used because, after a value is loaded into an SRAM cell, it remains unchanged until it is explicitly altered or until power is removed from the device. |
| SROM | An acronym for supervisory read only memory. The SROM holds code that is used to boot the device, calibrate circuitry, and perform flash operations. The functions of the SROM may be accessed in normal user code, operating from flash. |
| stop bit | A signal following a character or block that prepares the receiving device to receive the next character or block. |
| synchronous | <ol style="list-style-type: none"> 1. A signal whose data is not acknowledged or acted upon until the next active edge of a clock signal. 2. A system whose operation is synchronized by a clock signal. |
| tri-state | A function whose output can adopt three states: 0, 1, and Z (high-impedance). The function does not drive any value in the Z state and, in many respects, may be considered to be disconnected from the rest of the circuit, allowing another output to drive the same net. |
| UART | A UART or universal asynchronous receiver-transmitter translates between parallel bits of data and serial bits. |
| user modules | Pre-built, pre-tested hardware/firmware peripheral functions that take care of managing and configuring the lower level analog and digital PSoC blocks. User modules also provide high level <i>API (Application Programming Interface)</i> for the peripheral function. |
| user space | The bank 0 space of the register map. The registers in this bank are more likely to be modified during normal program execution and not just during initialization. Registers in bank 1 are most likely to be modified only during the initialization phase of the program. |
| V _{DD} | A name for a power net meaning “voltage drain.” The most positive power supply signal. Usually 5 V or 3.3 V. |
| V _{SS} | A name for a power net meaning “voltage source.” The most negative power supply signal. |
| watchdog timer | A timer that must be serviced periodically. If it is not serviced, the CPU resets after a specified period of time. |



Document History Page

| Document Title: CY8C21334/CY8C21534, Automotive – Extended Temperature PSoC® Programmable System-on-Chip™ Document Number: 38-12038 | | | | |
|--|---------|-----------------|-----------------|--|
| Revision | ECN | Orig. of Change | Submission Date | Description of Change |
| ** | 350496 | HMT | 04/18/05 | New silicon and document (Revision **). |
| *A | 395740 | HMT | 09/14/05 | Update I _{SB} and I _{SBH} DC Chip-Level Specification notes for qual. Update copyright, zip code, and CY Perform logo. Make data sheet Final. |
| *B | 422602 | HMT | 02/03/06 | Modify Storage Temperature and add recommended usage and related notes. Update AC Chip-Level Spec., F _{CPU1} . Add ISSP note to pinout tables. Implement CY QFN standard. Add CY corporate address. Update trademarks. |
| *C | 2101387 | AESA | 02/20/08 | Post to www.cypress.com |
| *D | 2641945 | OGNE / PYRS | 01/21/09 | Changed 25 mA Drive on All GPIO under Programmable Pin Configurations to 25 mA Sink, 10 mA Drive on All GPIO Changed Analog-to-digital converters (single or dual, with 8-bit resolution) under Analog-to-digital converters (single or dual, with up to 10-bit resolution) Updated template. Added Note in Ordering Information section. Changed title from PSoC Mixed-Signal Array to PSoC Programmable System-on-Chip |
| *E | 2703345 | VIVG / PYRS | 05/07/09 | Updated Getting Started section. Replaced Designing with User Modules section with Designing with PSoC Designer section. Updated Features list and PSoC Functional Overview section. Updated some AC Specification values to conform to a +/-4% accurate IMO (no order of magnitude changes). Added a note to I2C specifications section to clarify the I2C SysClk dependency. Added the Development Tool Selection section. Deleted some inapplicable or redundant information. Changed the title. Updated the PDF Bookmarks. |
| *F | 2822792 | BTK / AESA | 12/07/2009 | Added T _{PRGH} , T _{PRGC} , I _{OL} , I _{OH} , F _{32KU} , DC _{ILO} , and T _{POWERUP} electrical specifications. Corrected the Flash _{ENT} electrical specification. Updated the text of footnotes 6 and 7. Added maximum values and updated typical values for T _{ERASEB} and T _{WRITE} electrical specifications. Replaced T _{RAMP} electrical specification with SR _{POWERUP} electrical specification. Added "Contents" on page 2. |
| *G | 2888007 | NJF | 03/30/2010 | Updated Cypress website links. Removed AC Analog Mux Bus Specifications. Added T _{BAKETEMP} and T _{BAKETIME} parameters in Absolute Maximum Ratings Updated Packaging Information . Removed Third Party Tools and Build a PSoC Emulator into your Board. Updated links in Sales, Solutions, and Legal Information . |



Document History Page (continued)

| Document Title: CY8C21334/CY8C21534, Automotive – Extended Temperature PSoC [®] Programmable System-on-Chip™ Document Number: 38-12038 | | | | |
|--|---------|-----------------|-----------------|--|
| Revision | ECN | Orig. of Change | Submission Date | Description of Change |
| *H | 3118809 | BTK / NJF | 08/11/2011 | Updated I ² C timing diagram to improve clarity. Updated wording, formatting, and notes of the AC Digital Block Specifications table to improve clarity. Added V _{DDP} , V _{DDL} , and V _{DDHV} electrical specifications to give more information for programming the device. Updated solder reflow temperature specifications to give more clarity. Updated the jitter specifications. Updated PSoC Device Characteristics table. Updated the F _{32KU} electrical specification. Updated DC POR and LVD Specifications to add specs for all POR and LVD levels. Updated note for R _{PD} electrical specification. Updated note for the T _{STG} electrical specification to add more clarity. Added Tape and Reel Information section. Updated Reference Information Section. Added F _{IMO6} electrical specification and Figure 6 on page 13 . Changed F _{IMO24} electrical specification to give it a ±5% frequency accuracy. Updated F _{CPU1} , F _{BLK5} , F _{MAX} , and F _{GPIO} electrical specifications and all AC Digital Block Specifications to support a ±5% accuracy oscillator. |
| *I | 3523799 | SMYU | 02/13/2012 | Updated Tape and Reel Information (51-51100 and 51-51101) |
| *J | 3904247 | JICG | 02/14/2013 | Updated Packaging Information (Updated Tape and Reel Information (spec 51-51101 – Changed revision from *B to *C)). |
| *K | 5166373 | SNPR | 03/08/2016 | Updated Packaging Information : spec 51-85077 – Changed revision from *E to *F. spec 51-85079 – Changed revision from *E to *F. Updated Tape and Reel Information : spec 51-51100 – Changed revision from *C to *D. Updated to new template. Completing Sunset Review. |
| *L | 5655080 | SNPR | 03/09/2017 | Updated to new template. Completing Sunset Review. |
| *M | 5987147 | AESATMP9 | 12/07/2017 | Updated logo and copyright. |



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